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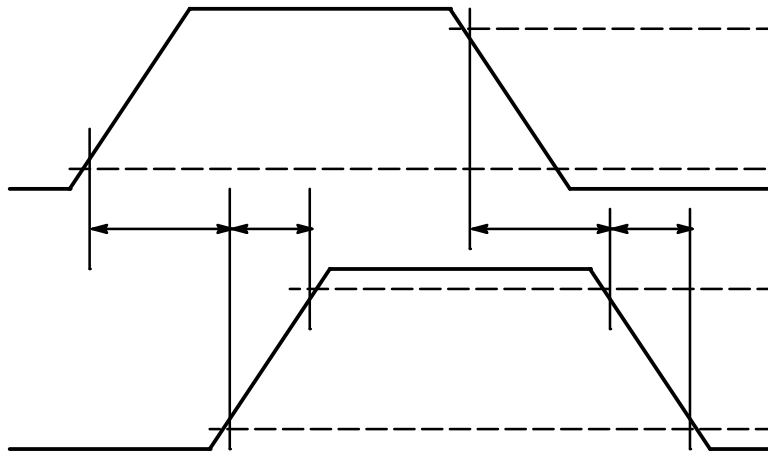
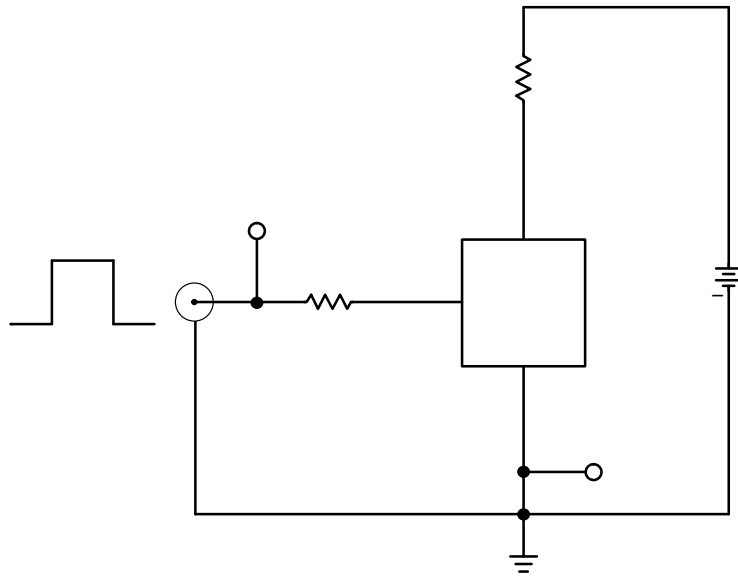
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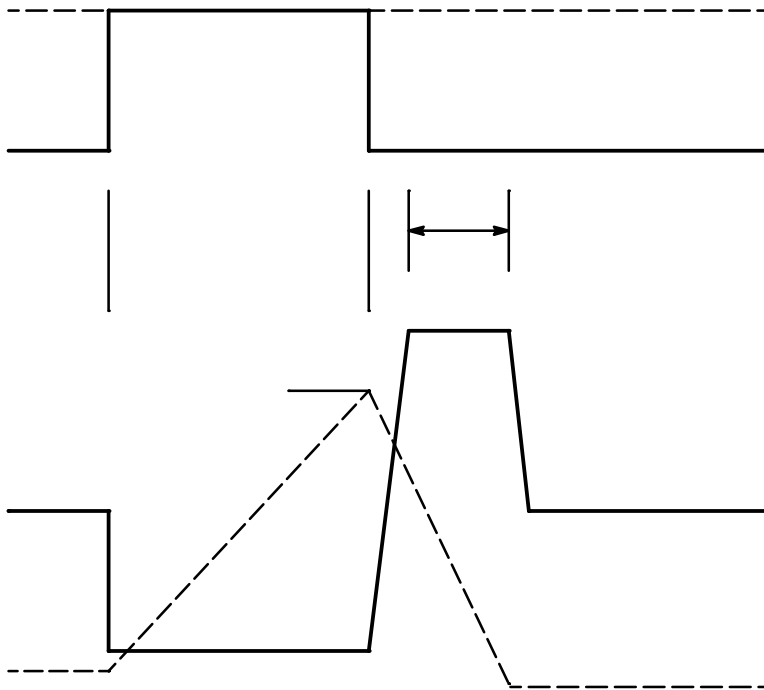
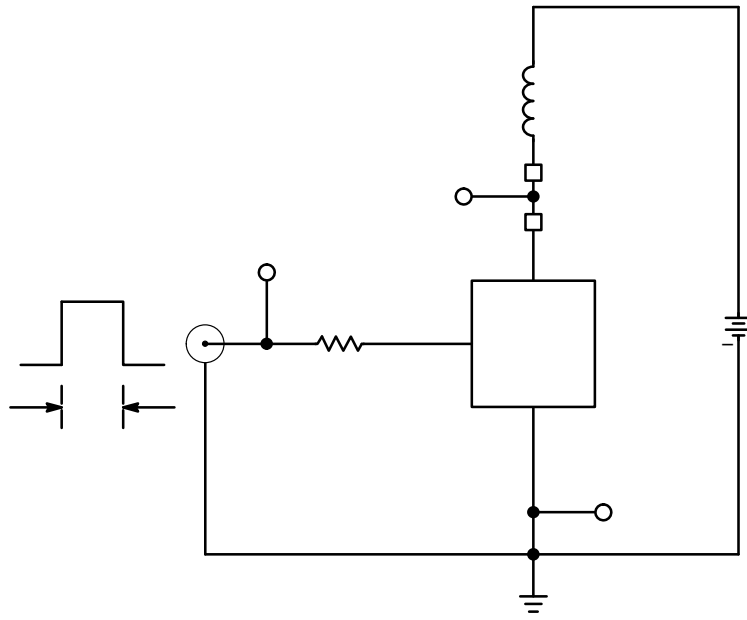
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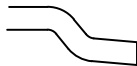
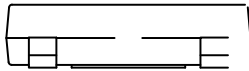
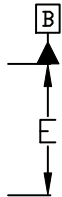




SCALE 1:1

SOT-223 (TO-261)
CASE 318E 04
ISSUE R

DATE 02 OCT 2018



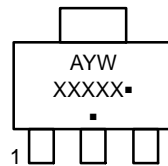
DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	1.50	1.63	1.75
A1	0.02	0.06	0.10
b			
D	6.30	6.50	6.70
E	3.30	3.50	3.70
e	2.30 BSC		

SOT-223 (TO-261)
CASE 318E 04
ISSUE R

DATE 02 OCT 2018

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|---|--|--|--|--|
| LE 1:
IN 1. BA E
2. C LLEC
3. EMI E
4. C LLEC | LE 2:
IN 1. AN DE
2. CA H DE
3. NC
4. CA H DE | LE 3:
IN 1. GA E
2. DAIN
3. CE
4. DAIN | LE 4:
IN 1. CE
2. DAIN
3. GA E
4. DAIN | LE 5:
IN 1. DAIN
2. GA E
3. CE
4. GA E |
| LE 6:
IN 1. E
2. IN
3.
4. IN | LE 7:
IN 1. AN DE 1
2. CA H DE
3. AN DE 2
4. CA H DE | LE 8:
CANCELLED | LE 9:
IN 1. IN
2. GAND
3. L G
4. GAND | LE 10:
IN 1. CA H DE
2. AN DE
3. GA E
4. AN DE |
| LE 11:
IN 1. M 1
2. M 2
3. GA E
4. M 2 | LE 12:
IN 1. IN
2.
3. NG
4. | LE 13:
IN 1. GA E
2. C LLEC
3. EMI E
4. C LLEC | | |

**GENERIC
MARKING DIAGRAM***




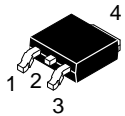
- A = Assembly Location
- Y = Year
- W = Work Week
- XXXXX = Specific Device Code
- = Pb Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	SOT-223 (TO-261)	PAGE 2 OF 2

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SCALE 1:1

DPAK (SINGLE GAUGE)
CASE 369C
ISSUE G

DATE 31 MAY 2023

STYLE 1: PIN 1. BASE 2. COLLECTOR 3. EMITTER 4. COLLECTOR	STYLE 2: PIN 1. GATE 2. DRAIN 3. SOURCE 4. DRAIN	STYLE 3: PIN 1. ANODE 2. CATHODE 3. ANODE 4. CATHODE	STYLE 4: PIN 1. CATHODE 2. ANODE 3. GATE 4. ANODE	STYLE 5: PIN 1. GATE 2. ANODE 3. CATHODE 4. ANODE
STYLE 6: PIN 1. MT1 2. MT2 3. GATE 4. MT2	STYLE 7: PIN 1. GATE 2. COLLECTOR 3. EMITTER 4. COLLECTOR	STYLE 8: PIN 1. N/C 2. CATHODE 3. ANODE 4. CATHODE	STYLE 9: PIN 1. ANODE 2. CATHODE 3. RESISTOR ADJUST 4. CATHODE	STYLE 10: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. ANODE

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